

V1.0.0

PIN Diode MMIC SP3T Reflective Switch 2-20GHz

#### **Features**

PIN Diode SP3T Reflective design

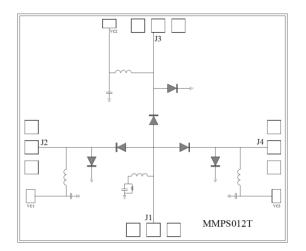
Frequency: 2-20GHz
Isolation: 48dB Typical
Insertion Loss: 0.9 dB Typical
Control Voltage:+5/-5V

Switching Speed: 20 ns TypicalDie Size: 2.0 x 1.7 x 0.1 mm

## **Typical Applications**

- Voltage control
- Fast Switching Speed
- Low Insertion Loss and High Isolation
- · Customization available upon request

## **Functional Block Diagram**



#### **Electrical Specifications**

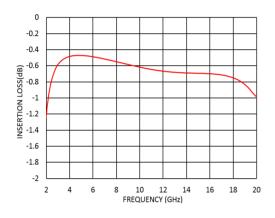
TA = +25°C, VCTL=+5/-5V , +12mA /-10mA Typical

Parameters	Min.	Тур.	Max.	Units
Frequency	2		20	GHz
Insertion Loss		0.7	1.2	dB
Isolation		48		dB
Input Return Loss (ON State)		15		dB
Output Return Loss (OFF State)		15		dB
P1dB - Output 1dB Compression		26		dBm
IIP3-Input Third Order Intercept		40		dBm
Switching Speed		20		ns

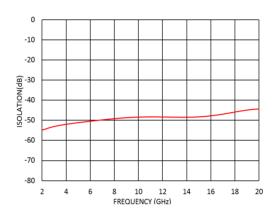


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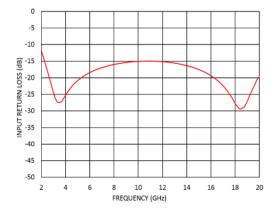
#### Insertion Loss vs. Frequency



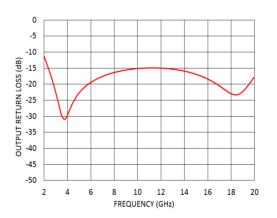
## Isolation vs. Frequency



#### Input Return Loss vs. Frequency



#### **Output Return Loss vs. Frequency**





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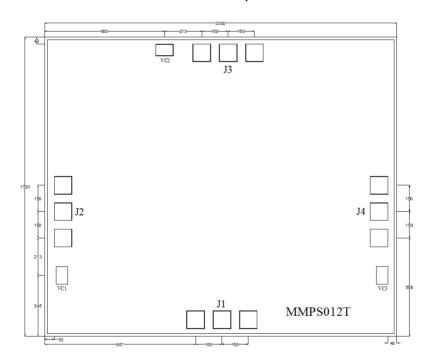
# **Absolute Maximum Ratings**

Max Incident C.W. RF Power	+31dBm
DC Reverse Voltage	25V
Bias Current	±50 mA
Operating Temperature	-55°C to +85 °C
Storage Temperature	-65°C to +150 °C



## **Outline Drawing:**

All Dimensions in µm



## **True Table**

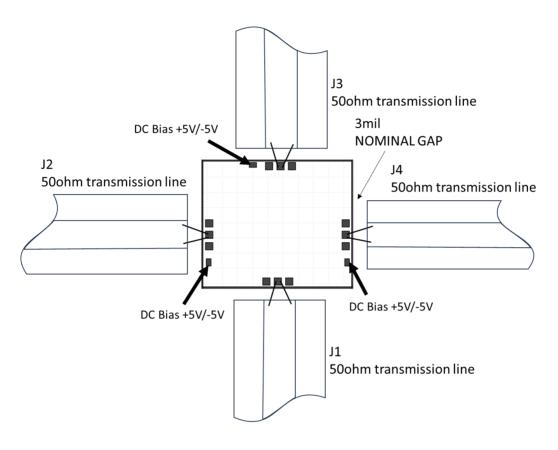
Со	ntrol Volta	ige		State	
VC1	VC2	VC3	J2→J1	J3→J1	J4→J1
-5V	+5V	+5V	ON	OFF	OFF
+5V	-5V	+5V	OFF	ON	OFF
+5V	+5V	-5V	OFF	OFF	ON



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# **Assembly Drawing**



#### Notes:

- 1. Die thickness: 100µm
- 2. Typical bond pad is 100\*100  $\mu m^2$
- 3. Bond pad mentalization: Gold
- 4. Backside metallization: Gold
- 5. Backside of the die (GND)
- 6. No connection required for unlabeled bond pads

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